

100V N-Channel Enhancement Mode MOSFET

Voltage **100 V** **$R_{DS(ON)}$** **9.2 m Ω**

Current **56 A** **Q_G (TYP)** **37.8 nC**

Feature

- $R_{DS(ON)}$, $V_{GS}@10V$, $I_D@15A < 9.2m\Omega$
- $R_{DS(ON)}$, $V_{GS}@4.5V$, $I_D@8A < 14m\Omega$
- High switching speed
- Low reverse transfer capacitance
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

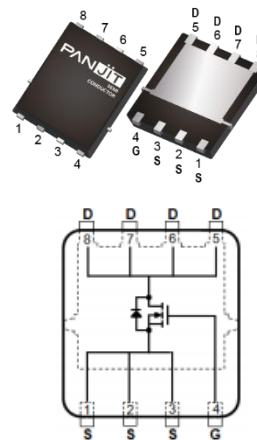
Mechanical Data

- Case: DFN5060-8L Package
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 0.0028 ounces, 0.08 grams

Application

- SR solutions of PD Charger, BMS, BLDC motor driver switch

DFN5060-8L



Top side view

Absolute Maximum Ratings ($T_A = 25^\circ\text{C}$ unless otherwise specified)

PARAMETER		SYMBOL	LIMIT	UNITS
Drain-Source Voltage		V_{DS}	100	V
Gate-Source Voltage		V_{GS}	+20 / -12	
Continuous Drain Current (Note 3)	$T_C=25^\circ\text{C}$	I_D	56	A
	$T_C=100^\circ\text{C}$		35.5	
Pulsed Drain Current	$T_C=25^\circ\text{C}$	I_{DM}	224	A
Single Pulse Avalanche Current (Note 5)		I_{AS}	43	A
Single Pulse Avalanche Energy (Note 5)		E_{AS}	92	mJ
Power Dissipation	$T_C=25^\circ\text{C}$	P_D	52	W
	$T_C=100^\circ\text{C}$		21	
Operating Junction and Storage Temperature Range		T_J, T_{STG}	-55~150	$^\circ\text{C}$

Thermal Characteristics

PARAMETER		SYMBOL	MAXIMUM	UNITS
Thermal Resistance	Junction-to-Case (Bottom)	$R_{\theta JC}$	2.4	$^\circ\text{C/W}$
	Junction-to-Case (Top)	$R_{\theta JT}$	TBD	$^\circ\text{C/W}$
	Junction-to-Ambient (Note.4)	$R_{\theta JA}$	50	$^\circ\text{C/W}$

Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Static						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	100	-	-	V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	1.2	1.6	2.5	
Drain-Source On-State Resistance (Note 1)	$R_{DS(on)}$	$V_{GS}=10V, I_D=15A$	-	8.1	9.2	m Ω
		$V_{GS}=4.5V, I_D=8A$	-	11.7	14	
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=100V, V_{GS}=0V$	-	-	1	μA
Gate-Source Leakage Current	I_{GSS}	$V_{GS}=+20V, V_{DS}=0V$	-	-	9.5	nA
Transfer characteristics (Note 1)	gfs	$V_{DS}=10V, I_D=3A$	-	11	-	S
Dynamic (Note 6)						
Total Gate Charge	Q_g	$V_{DS}=50V, I_D=8.5A,$ $V_{GS}=10V$	-	37.8	-	nC
Gate-Source Charge	Q_{gs}		-	7.8	-	
Gate-Drain Charge	Q_{gd}		-	8.4	-	
Plateau Voltage	V_{GP}		-	3	-	V
Input Capacitance	C_{iss}	$V_{DS}=50V, V_{GS}=0V,$ $f=1.0MHz$	-	2250	-	pF
Output Capacitance	C_{oss}		-	410	-	
Reverse Transfer Capacitance	C_{rss}		-	25	-	
Turn-On Delay Time	$t_{d(on)}$	$V_{DD}=50V, I_D=1A,$ $V_{GS}=10V, R_G=6\Omega$ (Note 2)	-	14.6	-	ns
Turn-On Rise Time	t_r		-	21.5	-	
Turn-Off Delay Time	$t_{d(off)}$		-	54	-	
Turn-Off Fall Time	t_f		-	84.3	-	
Gate Resistance	R_g	$f = 1.0MHz$	-	1.43	-	Ω
Drain-Source Diode						
Diode Forward Voltage	V_{SD}	$I_S=1A, V_{GS}=0V$	-	-	1	V
Reverse Recovery Charge	Q_{rr}	$I_{SD} = 10A$	-	75.1	-	nC
Reverse Recovery Time	T_{rr}	$di/dt = 100A/\mu s$	-	49.2	-	ns

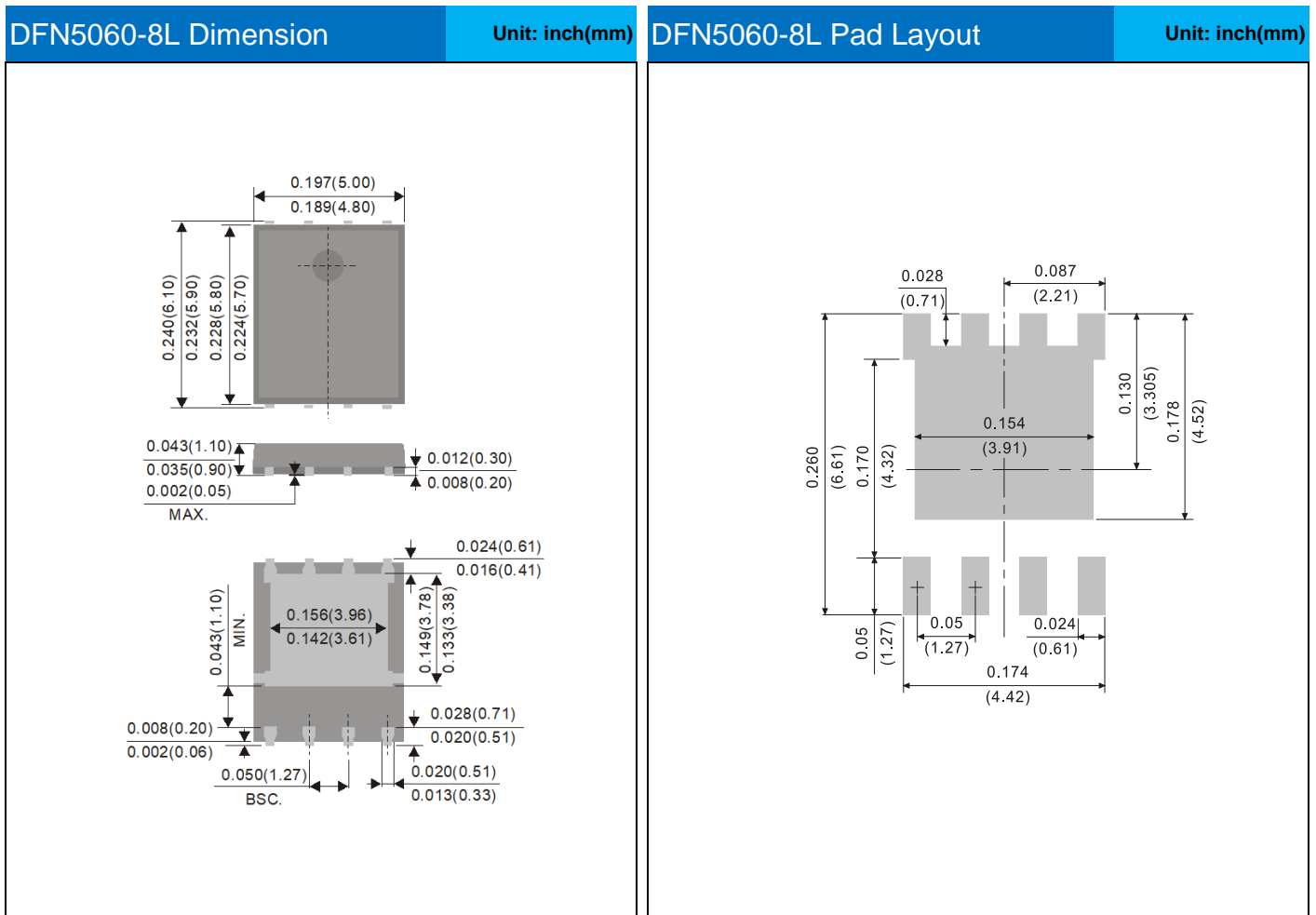
NOTES :

1. Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$
2. Essentially independent of operating temperature typical characteristics.
3. The maximum current rating is package limited.
4. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch² with 2oz.square pad of copper.
5. The test condition is $L=0.1mH, I_{AS}=43A, V_{DD}=50V, V_{GS}=10V, R_G=25\Omega$, Starting $T_J=25^\circ C$
6. Guaranteed by design, not subject to production testing.

Product and Packing Information

Part No.	Package Type	Packing Type	Marking
PSMQC092N10LS1	DFN5060-8L	3000pcs / 13" reel	092N10LS

Packaging Information & Mounting Pad Layout



Marking Diagram

PJ	Y = Year Code
092N10LS	W = Week Code (A~Z)
YWLL x	LL = Lot Code (00~99)
	x = Production Line Code

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